502607211 12/18/2013

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2653616

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
RYOTA SASAJIMA	09/18/2013
YOSHINOBU NAKAMURA	09/18/2013
KAZUYUKI OKUDA	09/18/2013

RECEIVING PARTY DATA

Name:	Hitachi Kokusai Electric Inc.
Street Address:	14-1, Sotokanda 4-chome
Internal Address:	Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	1018980

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14027799

CORRESPONDENCE DATA

 Fax Number:
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Address Line 4: PHILADELPHIA, PENNSYLVANIA 19103

ATTORNEY DOCKET NUMBER:	HITACHI13-21210017US01
NAME OF SUBMITTER:	DANIEL N. CALDER

PATENT REEL: 031810 FRAME: 0151 \$40,00 14027

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Signature:	/Daniel N. Calder/
Date:	12/18/2013
Total Attachments: 5 source=21210017US01_DecandAssign_EF source=21210017US01_DecandAssign_EF source=21210017US01_DecandAssign_EF source=21210017US01_DecandAssign_EF source=21210017US01_DecandAssign_EF	S#page2.tif S#page3.tif S#page4.tif

PATENT REEL: 031810 FRAME: 0152

ASSIGNMENT AND DECLARATION

With respect to the invention titled

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE, SUBSTRATE PROCESSING APPARATUS, AND RECORDING MEDIUM

for which the undersigned has authorized or prepared an application for United States Letters Patent, U.S. Patent Application No. 14/027,799 , filed on September 16, 2013,

I (the undersigned) hereby state the following.

DECLARATION

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than 5 years, or both.

ASSIGNMENT

The undersigned hereby authorizes assignee or assignee's representative to insert the Application Number and the filing date of this application if they are unknown at the time of execution of this assignment.

Assignee

HITACHI KOKUSAI ELECTRIC INC.

Assignee	State	or	Country
of Incorp	oratio	n	

Japan

Assignee Address

14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 1018980, Japan

Assignee is desirous of acquiring the entire right, title and interest in the invention, all applications for and all letters patent issued on the invention.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee and assignee's successors, assigns and legal representatives the entire right, title and interest in the invention and all patent applications thereon, including, but not limited to, the application for United States Letters Patent entitled as above, and all divisions and continuations thereof, and in all letters patent, including all reissues and reexaminations thereof, throughout the world, including the right to claim priority under the Paris Convention or other treaty.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, to supply all information and evidence relating to the making and practice of the invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention throughout the world for the benefit of the assignee, and to execute all instruments proper to carry out the intent of this instrument.

The undersigned warrants that the rights and property herein conveyed are free and clear of any encumbrance.

AND this Assignment may be executed in multiple counterparts, each of which shall be deemed to be an original of this Assignment. Additionally, the undersigned hereby authorizes our attorneys to collect the signature pages of each executed counterpart and to attach those signature pages to a single copy of this instrument, which single copy and attached signature pages together shall constitute an original of this Assignment.

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SIGNATURE SHEET FOR DECLARATION AND ASSIGNMENT

Inventor's Name	SASAJIMA, Ryota	
Inventor's Signature	Sasadima Ryota	
Date	September 18, 2013	
Signed at	Toyama-shi, Japan	
	(City and Country)	
STATEM	ENT OF WITNESS (optional):	
	I,	
	Name of Witness	
was perso	onally present and did see SASAJIMA, Ryota	
	inventor identified above	
execute t	his Assignment on and such Assignor is person date	ıally knowr
to me to h	be the person described herein.	
Witness Signature		
must accor	tion data sheet (PTO/SB/14 or equivalent), including naming the entire invermpany this form. Use a separate form for each inventor; or check the box he attached page(s) to list additional inventors.	

3

Additional inventors are being named on the 2 supplemental sheet(s) attached hereto.

SUPPLEMENTAL SHEET FOR DECLARATION AND ASSIGNMENT

Inventor's Name	NAKAMURA, Yoshinobu
Inventor's Signature	Nakamura Soshinobu September 18. 2013
Date	September 18.2013
Signed at	Toyama-shi, Japan
•	(City and Country)
STATEME	ENT OF WITNESS (optional):
	Ι,
	Name of Witness
was perso	nally present and did see NAKAMURA, Yoshinobu
	inventor identified above
execute th	is Assignment on and such Assignor is personally known date
to me to be	e the person described herein.
Witness Signature	

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SUPPLEMENTAL SHEET FOR DECLARATION AND ASSIGNMENT

Inventor's Name	OKUDA, Kazuyuki	
Inventor's Signature	Okada Kazuyuki	
Date _	September 18, 2013	
Signed at	Toyama-shi, Japan	
	(City and Country)	
STATEME	NT OF WITNESS (optional):	
	Ι,	
	Name of Witness	
was persor	nally present and did see OKUDA, Kazuyuki	
	inventor identified above	
execute th	is Assignment on and such Assignor is personally know date	7 .
to me to be	e the person described herein.	
Witness Signature		

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RECORDED: 12/18/2013

PATENT REEL: 031810 FRAME: 0157